

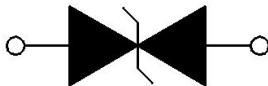
Features

- 2-pin lead-less package
- Junction capacitance (Max value: 15pF)
- Peak Pulse current (8/20 μ s) MAX : 8A
- IEC61000-4-2 (ESD) $\pm$ 30kV (air), $\pm$ 30kV (contact)
- Low leakage current
- Working voltages:5V
- RoHS Compliant

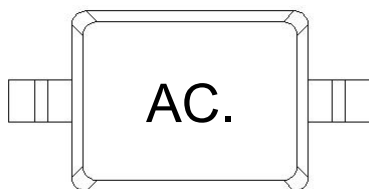
Mechanica Characteristics

- Package: SOD-323
- Lead Finish:Matte Tin
- Case Material: "Green" Molding Compound.
- UL Flammability Classification Rating 94V-0
- Moisture Sensitivity: Level 3 per J-STD-020
- Tape Reel :3000pcs

Appearance & Symbo



Bi-directional



AC. =Marking Code

Applications

- LED Lighting Modules
- RS232/RS485
- CAN and LIN Bus
- Portable Instrumentation
- General Purpose I/O
- Automotive application

Absolute Maximum Ratings (T=25°C, RH=45%-75%, unless otherwi

Parameters	Symbol	Value	Unit
Peak Pulse Power (tp=8/20μs waveform)	P _{PP}	95	W
Peak Pulse Current (8/20μs)	I _{PP}	8	A
ESD per IEC 61000-4-2 (Air) ESD per IEC 61000-4-2 (Contact)	V _{ESD}	±30 ±30	KV
Operating Temperature Range	T _J	-55 to +125	°C
Storage Temperature Range	T _{stg}	-55 to +150	°C

Electrical Characteristics (T=25°C, RH=45%-75%, unless otherwise noted

Parameter	Symbol	Test Condition	Min	Typ	Max	Unit
Reverse Working Voltage	V _{RWM}				5	V
Reverse Breakdown Voltage	V _{BR}	I _R = 1mA	6		9	V
Reverse Leakage Current	I _R	V _R = 5V			0.05	uA
Clamping voltage	V _C	I _{PP} = 1A, T _P =8/20us			8	V
Clamping voltage	V _C	I _{PP} = 8A, T _P =8/20us			12	V
Junction capacitance	C _j	V _R =0V, f =1MHz			15	pF

Typical Characteristics

FIG1: Power rating derating curve

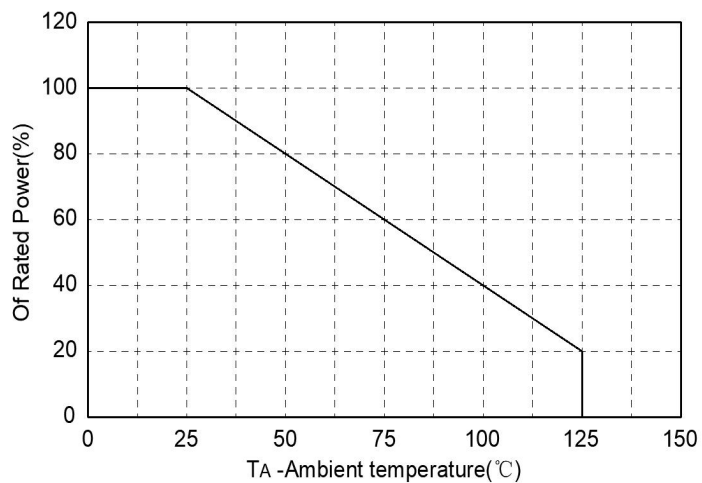


FIG2: pulse Waveform

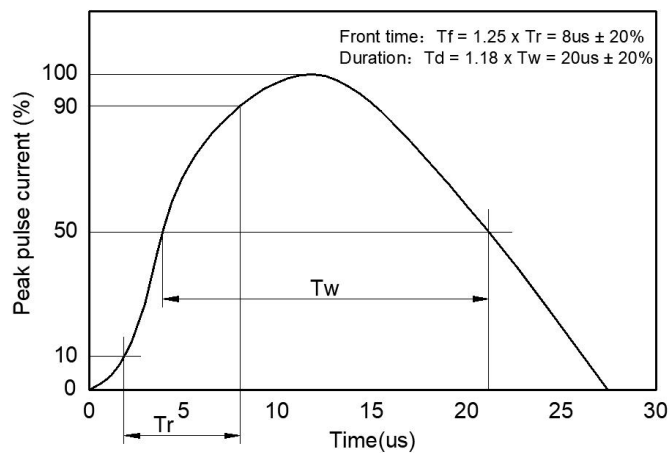


FIG3: Capacitance between terminals characteristics

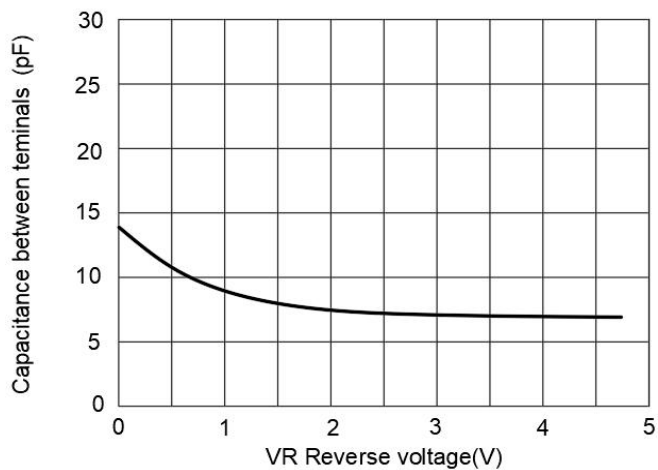
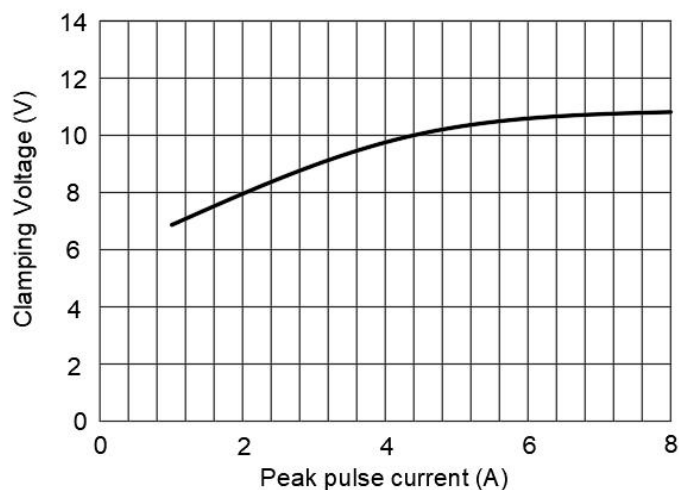
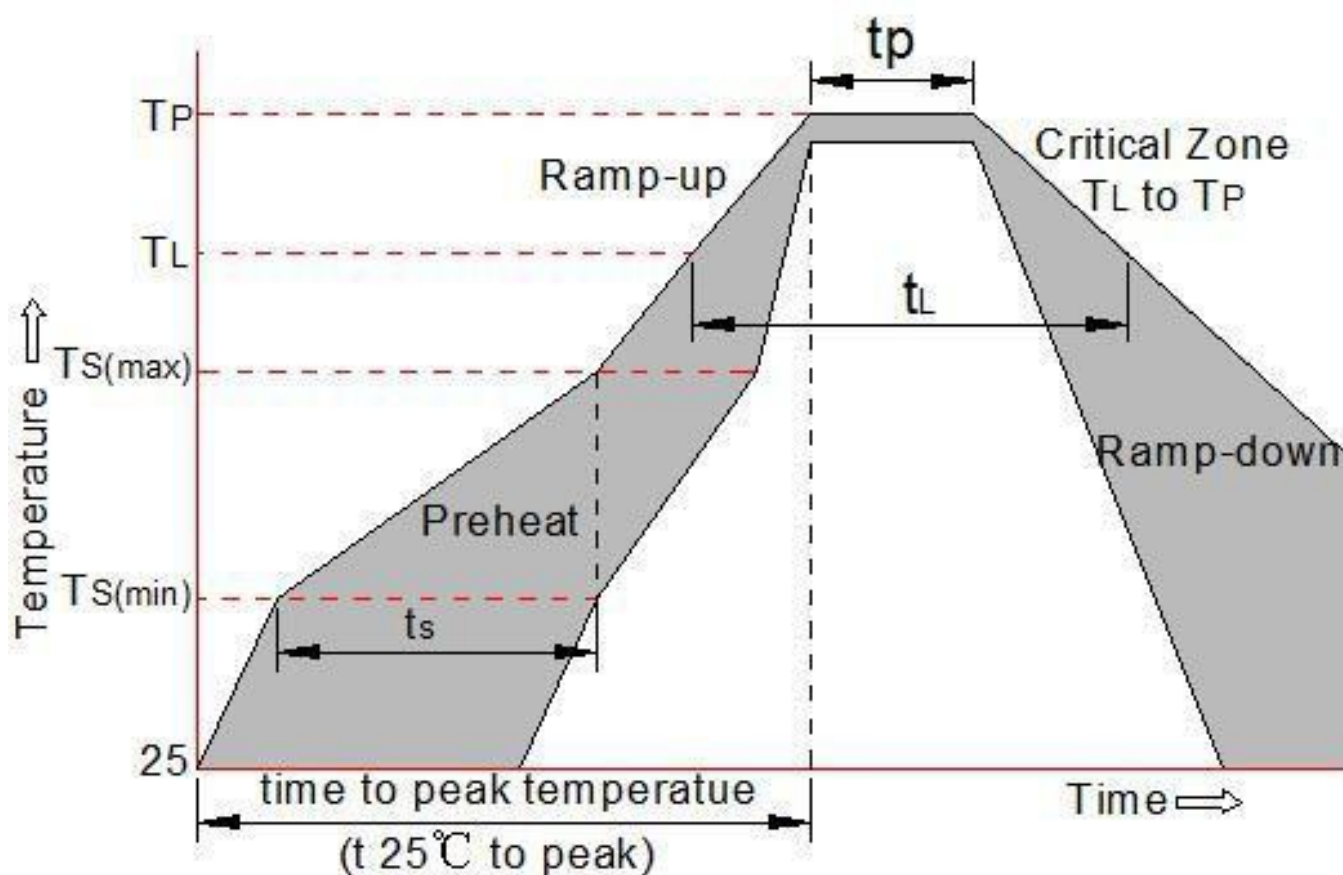


FIG4: Clamping Voltage vs. Peak Pulse Current

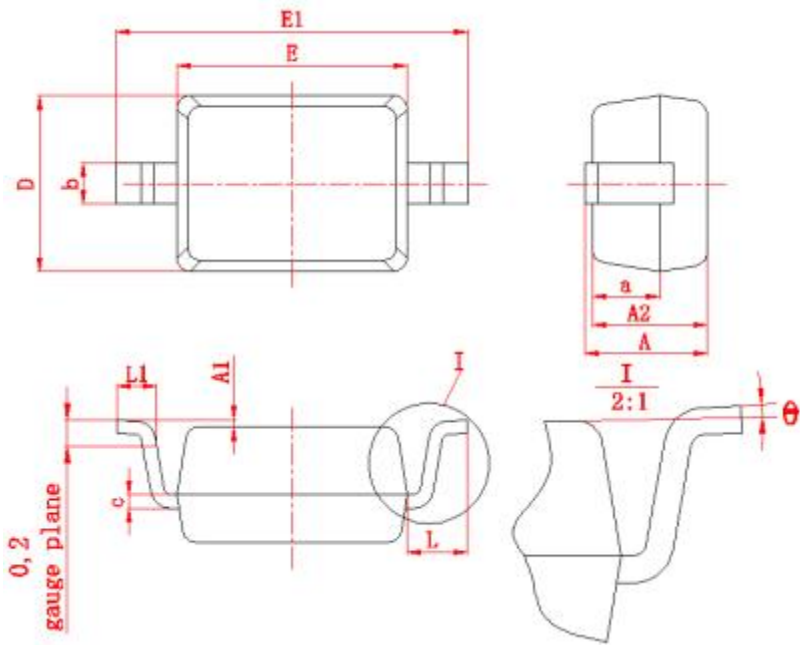


Soldering parameters

Reflow Condition		Pb-Free assembly see as bellow
Pre Heat	-Temperature Min ($T_{s(min)}$)	+150°C
	-Temperature Max($T_{s(max)}$)	+200°C
	-Time (Min to Max) (t_s)	60-180 secs.
Average ramp up rate (Liquid us Temp (T_L) to peak)		3°C/sec. Max
$T_{s(max)}$ to T_L - Ramp-up Rate		3°C/sec. Max
Reflow	-Temperature(T_L) (Liquid us)	+217°C
	-Temperature(t_L)	60-150 secs.
Peak Temp (T_P)		+260(+0/-5)°C
Time within 5°C of actual Peak Temp (t_p)		30 secs. Max
Ramp-down Rate		6°C/sec. Max
Time 25°C to Peak Temp (T_P)		8 min. Max
Do not exceed		+260°C

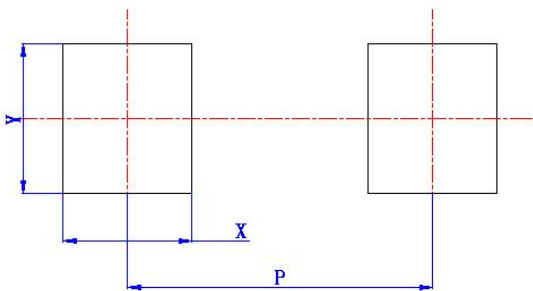


Package mechanical data



Symbol	Dimension in Millimeters	
	min	max
A	0.80	1.05
A1	0	0.1
A2	0.8	0.95
a	(0.5)	
D	1.2	1.4
E	1.6	1.8
E1	2.5	2.75
b	0.25	0.35
c	0.08	0.15
L	(0.475)	
L1	0.25	0.45
θ	0°	8°

Suggested Land Pattern



Symbol	Dimension in Millimeters
	typ
X	(0.7)
Y	(0.7)
P	(2.3)